



PRODUCT SPECIFICATION

Part Number

PG24064B-O Series

CUSTOMER	
CUSTOMER PART NUMBER	
DESCRIPTION	
APPROVED BY	
DATE	

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[illegible]

1. Part number breakdown

P _ _ - _ _ - _ - _ - _ - _ - _

1 2 3 4 5 6 7 8 9

Replace each Space (_) with the following letters and or numbers

1. P-tec LCD Type	C = Character G = Graphic COG = Chip On Glass	COF = Chip On Flex TAB = Tape Automated Bonding TFT = Thin-film Transistor
2. LCD Model	Example for Character: 2002A = 20 Characters x 2 Lines w/ Pins on Left side and 116mm x 37 x 12.7mm overall size Example for Graphic: 12864B = 128 Dots per row x 64 Dots per Column w/ Pins on lower side and 93mm x 70 x 8.8mm overall size	
3. Fluid Type	T = TN/Grey Y = STN/Yellow Green G = STN/ Grey	B = STN/ Blue F = FSTN/ White N = FSTN/ Black
4. Backlight/polorizer	NF = None/Transflective NM = None/Transmissive NR = None/Reflective EF = EL/Transflective EM = EL/Transmissive	LF = LED/Transflective LM = LED/Transmissive CF = CCFL/Transflective CM = CCFL=Transmissive
5. Backlight Color	(If no backlight provided move on to viewing angle [6.]) B = Blue/Green Y = Yellow G = Green	
6. Viewing Angle	D = 6:00 U = 12:00	R = 3:00 L = 9:00
7. Internal Number	Single Letter for internal purposes	
8. Extended Temperature	This space is blank if operating temperature is standard 0°C to 50°C An X will be visible if the LCD is Extended operating temperature	
9. Customer Specials or List of Value-added items	Usually blank unless customer requests some modifications. Can be several Letters long.	



2. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.

3. General Specification

Item	Dimension	Unit
Number of Dots	240 x 64	—
Module dimension(None Backlight)	180.0 x 65.0 x 11.0 (MAX)	mm
Module dimension(With Backlight)	180.0 x 65.0 x 16.0 (MAX)	mm
View area	132.2 x 39.2	mm
Active area	127.16 x 33.88	mm
Dot size	0.49 x 0.49	mm
Dot pitch	0.53x 0.53	mm
LCD type	STN	
Duty	1/64	
View direction	6 o'clock or 12 o'clock	
Backlight Type	None, YELLOW-GREEN backlight, WHITE backlight	

4. Absolute Maximum Ratings

Item		Symbol	Min	Max	Unit
Input Voltage		V_I	-0.3	$V_{DD}+0.3$	V
Supply Voltage For Logic		$V_{DD}-V_{SS}$	-0.3	7.0	V
Supply Voltage For LCD		$V_{DD}-V_0$	0	16	V
Standard Temperature LCM	Operating Temp.	Top	0	50	°C
	Storage Temp.	Tstr	-10	60	°C
Wide Temperature LCM	Operating Temp.	Top	-20	70	°C
	Storage Temp.	Tstr	-30	80	°C

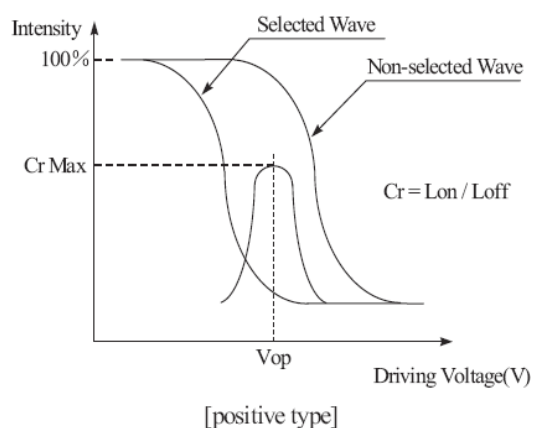
5. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	$V_{DD}-V_{SS}$	—	4.5	5.0	5.5	V
Supply Voltage For LCD	$V_{DD}-V_0$	Ta=25°C	12.0	12.5	13.2	V
Input High Volt.	V_{IH}	—	0.7 V_{DD}	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	V_{SS}	—	0.3 V_{DD}	V
Supply Current	I_{DD}	$V_{DD}=5V$	9.0	9.9	12.0	mA
Supply Voltage of Yellow-green backlight	V_{LED}	Forward current =630 mA Number of LED die 2x63= 126	3.8	4.2	4.3	V
Supply Voltage of White backlight	V_{LED}	Forward current =60 mA Number of LED die 4	2.8	3.1	3.3	V

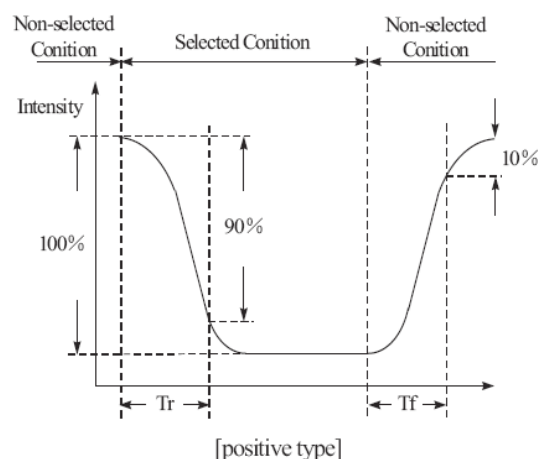
6. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) θ	$CR \geq 2$	-20	—	35	deg
	(H) ϕ	$CR \geq 2$	-30	—	30	deg
Contrast Ratio	CR	—	—	3	—	—
Response Time	T rise	—	—	—	250	ms
	T fall	—	—	—	250	ms

Definition of Operation Voltage (Vop)



Definition of Response Time (Tr, Tf)



Conditions :

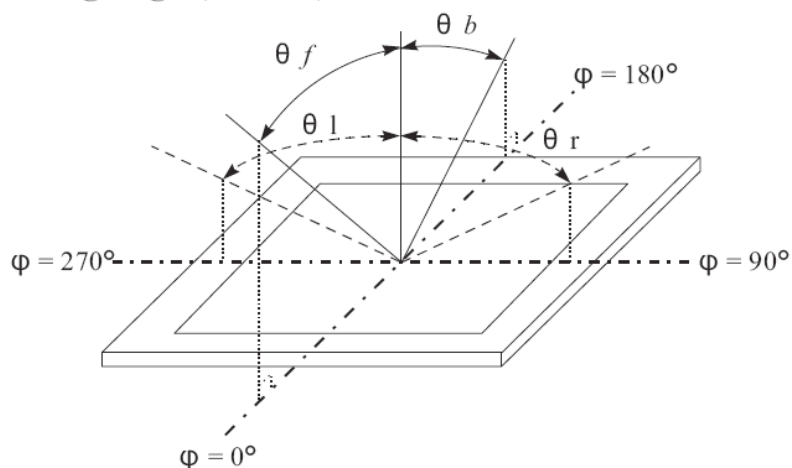
Operating Voltage : Vop

Viewing Angle(θ , ϕ) : 0° , 0°

Frame Frequency : 64 HZ

Driving Waveform : 1/N duty, 1/a bias

Definition of viewing angle($CR \geq 2$)

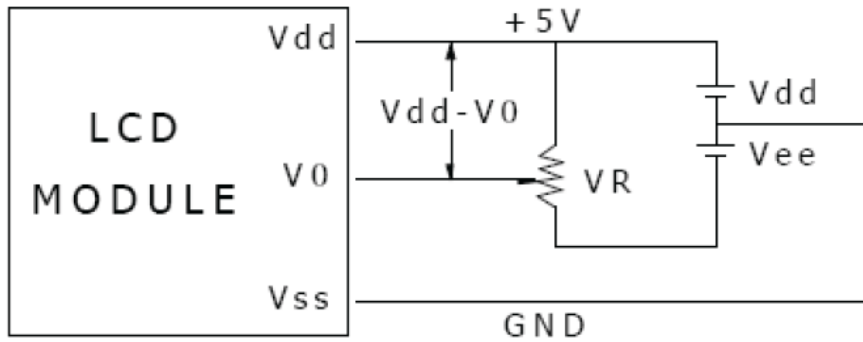


7. Interface Pin Function

Pin No.	Symbol	Level	Description
1	FGND		Frame GND
2	V _{SS}	0V	Ground
3	V _{DD}	5.0V	Supply Voltage for logic
4	V ₀		Supply voltage for LCD
5	/WR	H/L	Write Data into T6963C
6	/RD	H/L	Read Data from T6963C
7	/CS	H/L	Chip enable for T6963C
8	C/D	H/L	Command/Data
9	NC		NC
10	/RST	H/L	Reset signal
11	DB0	H/L	Data bit 0
12	DB1	H/L	Data bit 1
13	DB2	H/L	Data bit 2
14	DB3	H/L	Data bit 3
15	DB4	H/L	Data bit 4
16	DB5	H/L	Data bit 5
17	DB6	H/L	Data bit 6
18	DB7	H/L	Data bit 7
19	FS	H/L	Pins for selection of font
20	NC		NC

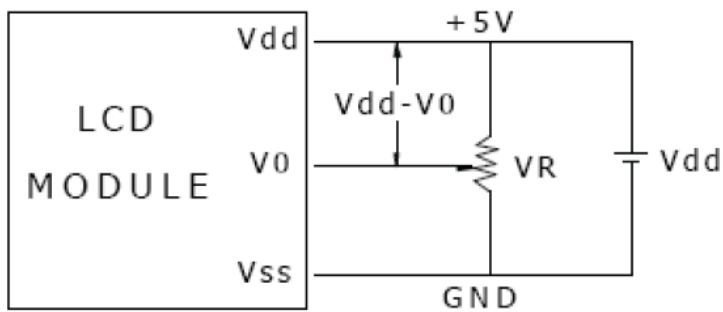
8. POWER SUPPLY

Without Negative Power on PCB



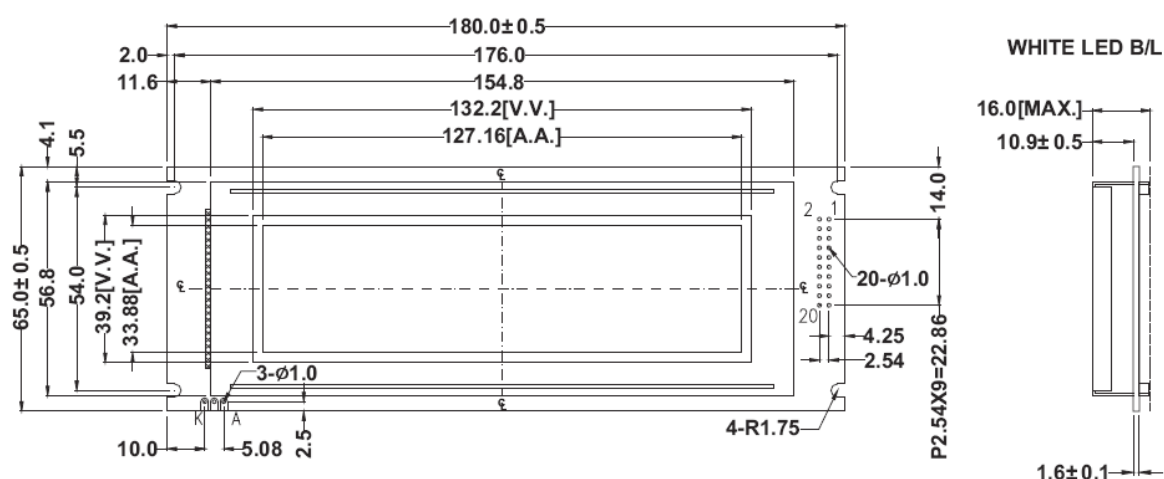
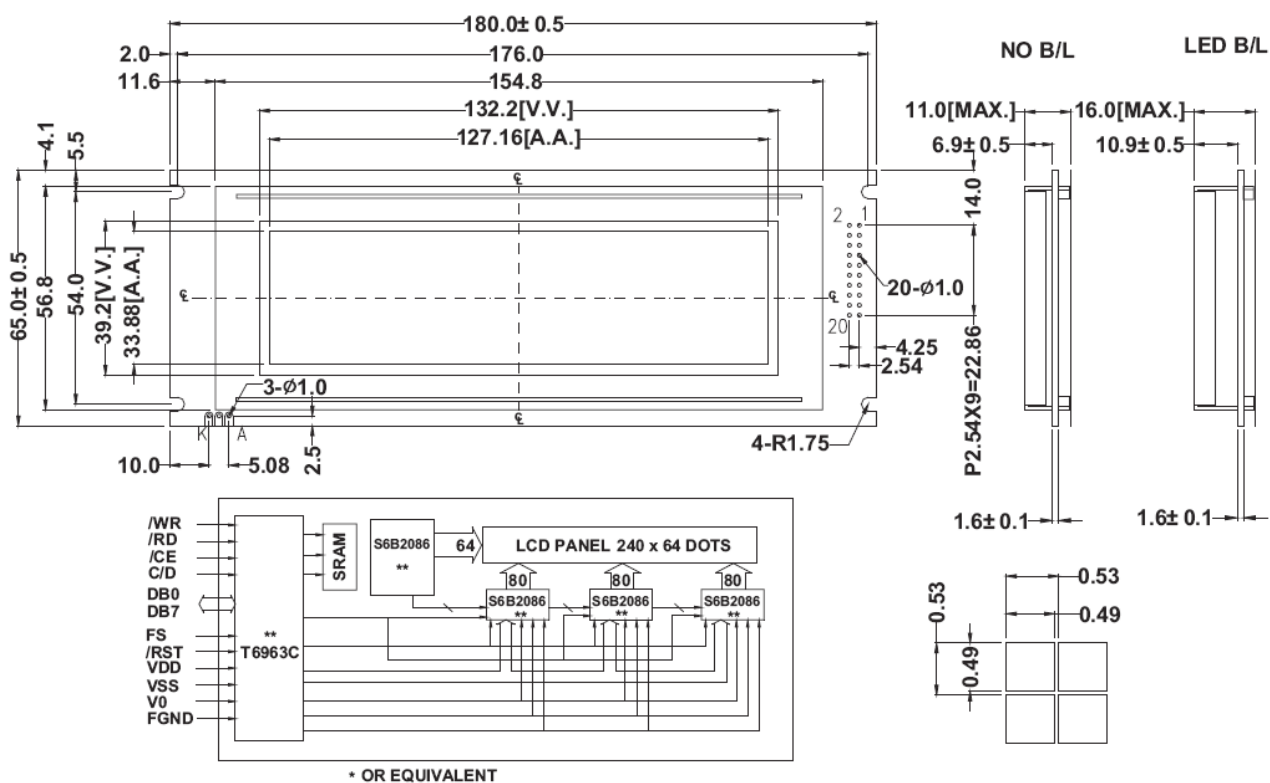
Vdd-V0: LCD Driving Voltage
VR: 10K - 20K

With Negative Power on PCB



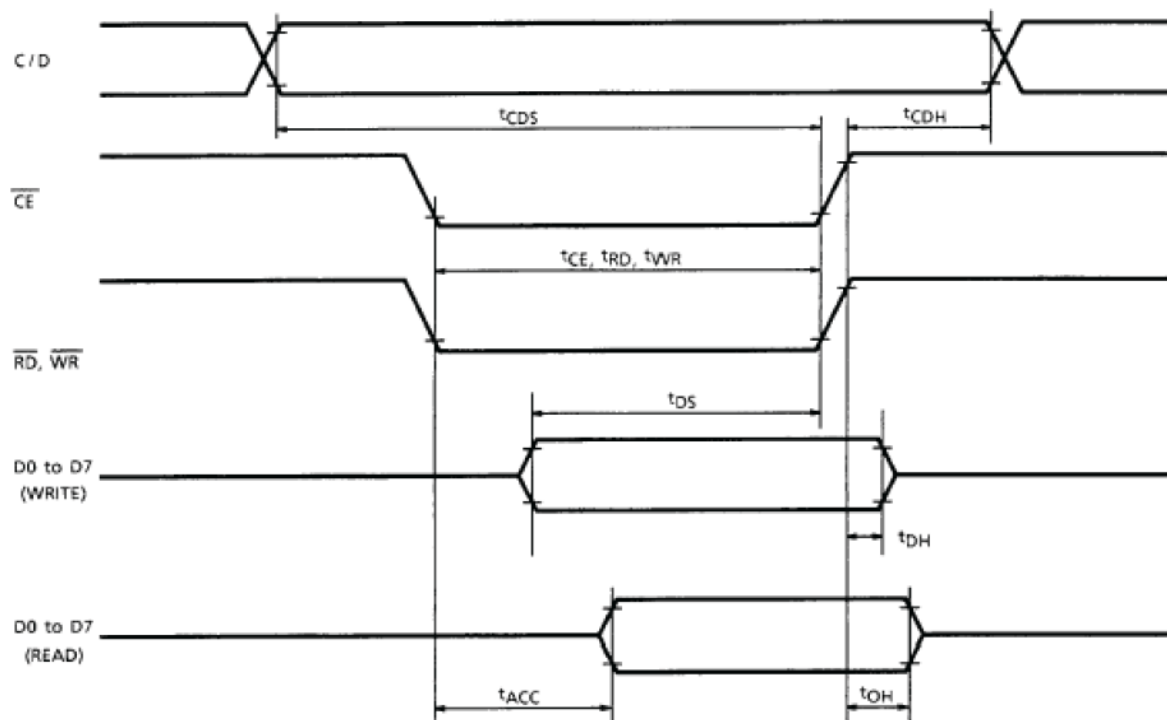
Vdd-V0: LCD Driving Voltage
VR: 10K - 20K

9. Contour Drawing & Block Diagram



10. Timing Characteristics

Bus Timing



TEST CONDITIONS (Unless otherwise noted, $V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20$ to $75^\circ C$)

ITEM	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
C/D Set-up Time	t_{CDS}	—	100	—	ns
C/D Hold Time	t_{CDH}	—	10	—	ns
CE, RD, WR Pulse Width	t_{CE}, t_{RD}, t_{WR}	—	80	—	ns
Data Set-up Time	t_{DS}	—	80	—	ns
Data Hold Time	t_{DH}	—	40	—	ns
Access Time	t_{ACC}	—	—	150	ns
Output Hold Time	t_{OH}	—	10	50	ns

11. Table of T6963C Commands

COMMAND DEFINITIONS

COMMAND	CODE	D1	D2	FUNCTION
REGISTERS SETTING	00100001	X address	Y address	Set Cursor Pointer
	00100010	Data	00H	Set Offset Register
	00100100	Low address	High address	Set Address Pointer
SET CONTROL WORD	01000000	Low address	High address	Set Text Home Address
	01000001	Columns	00H	Set Text Area
	01000010	Low address	High address	Set Graphic Home Address
	01000011	Columns	00H	Set Graphic Area
MODE SET	1000X000	—	—	OR mode
	1000X001	—	—	EXOR mode
	1000X011	—	—	AND mode
	1000X100	—	—	Text Attribute mode
	10000XXX	—	—	Internal CG ROM mode
	10001XXX	—	—	External CG RAM mode
DISPLAY MODE	10010000	—	—	Display off
	1001XX10	—	—	Cursor on, blink off
	1001XX11	—	—	Cursor on, blink on
	100101XX	—	—	Text on, graphic off
	100110XX	—	—	Text off, graphic on
	100111XX	—	—	Text on, graphic on
CURSOR PATTERN SELECT	10100000	—	—	1-line cursor
	10100001	—	—	2-line cursor
	10100010	—	—	3-line cursor
	10100011	—	—	4-line cursor
	10100100	—	—	5-line cursor
	10100101	—	—	6-line cursor
	10100110	—	—	7-line cursor
	10100111	—	—	8-line cursor
DATA AUTO READ / WRITE	10110000	—	—	Set Data Auto Write
	10110001	—	—	Set Data Auto Read
	10110010	—	—	Auto Reset
DATA READ / WRITE	11000000	Data	—	Data Write and Increment ADP
	11000001	—	—	Data Read and Increment ADP
	11000010	Data	—	Data Write and Decrement ADP
	11000011	—	—	Data Read and Decrement ADP
	11000100	Data	—	Data Write and Nonvariable ADP
	11000101	—	—	Data Read and Nonvariable ADP
SCREEN PEEK	11100000	—	—	Screen Peek
SCREEN COPY	11101000	—	—	Screen Copy

X : invalid

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COMMAND	CODE	D1	D2	FUNCTION
BIT SET / RESET	11110XXX	—	—	Bit Reset
	11111XXX	—	—	Bit Set
	1111X000	—	—	Bit 0 (LSB)
	1111X001	—	—	Bit 1
	1111X010	—	—	Bit 2
	1111X011	—	—	Bit 3
	1111X100	—	—	Bit 4
	1111X101	—	—	Bit 5
	1111X110	—	—	Bit 6
	1111X111	—	—	Bit 7 (MSB)

X : invalid

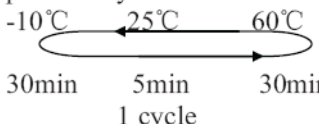
12.Quality Assurance

Screen Cosmetic Criteria

Item	Defect	Judgment Criterion	Partition
1	Spots	A)Clear <u>Size: d mm</u> <u>Acceptable Qty in active area</u> $d \leq 0.1$ Disregard $0.1 < d \leq 0.2$ 6 $0.2 < d \leq 0.3$ 2 $0.3 < d$ 0 Note: Including pin holes and defective dots which must be within one pixel size. B)Unclear <u>Size: d mm</u> <u>Acceptable Qty in active area</u> $d \leq 0.2$ Disregard $0.2 < d \leq 0.5$ 6 $0.5 < d \leq 0.7$ 2 $0.7 < d$ 0	Minor
2	Bubbles in Polarizer	<u>Size: d mm</u> <u>Acceptable Qty in active area</u> $d \leq 0.3$ Disregard $0.3 < d \leq 1.0$ 3 $1.0 < d \leq 1.5$ 1 $1.5 < d$ 0	Minor
3	Scratch	In accordance with spots cosmetic criteria. When the light reflects on the panel surface, the scratches are not to be remarkable.	Minor
4	Allowable Density	Above defects should be separated more than 30mm each other.	Minor
5	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels. Back-light type should be judged with back-light on state only.	Minor

13. Reliability

Content of Reliability Test

Environmental Test			
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	60℃ 96hrs	—
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-10℃ 96hrs	—
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	50℃ 96hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	0℃ 96hrs	—
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60℃, 90%RH 96hrs	—
High Temperature/ Humidity Operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	50℃, 90%RH 96hrs	—
Temperature Cycle	Endurance test applying the low and high temperature cycle. <div style="text-align: center;">  <p>-10℃ 25℃ 60℃</p> <p>30min 5min 30min</p> <p>1 cycle</p> </div>	-10℃/60℃ 10 cycles	—
Mechanical Test			
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hrs	—
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign wave 11 msdc 3 times of each direction	—

***Supply voltage for logic system=5V. Supply voltage for LCD system =Operating voltage at 25℃